



#### 100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> Tc = +25°C
40014	$23m\Omega$ @ $V_{GS} = 10V$	45A
100V	$30m\Omega$ @ $V_{GS} = 6V$	38A

### **Description**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Synchronous rectifiers
- DC-DC converters
- Primary side switching

### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable And Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H025LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

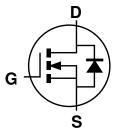


PowerDI5060-8

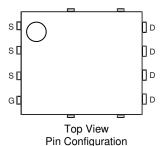


Top View

**Bottom View** 



Internal Schematic



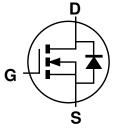
Site 2:

PowerDI5060-8/SWP (Type UX)

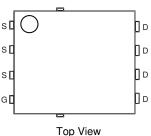


Top View

**Bottom View** 



Internal Schematic



Pin Configuration

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

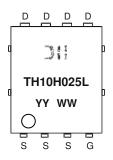


### Ordering Information (Note 4)

Part Number	Pookogo	Packing		
Part Number	Package	Qty.	Carrier	
DMTH10H025LPSQ-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH10H025LPSQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**





### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	100	V
Gate-Source Voltage		$V_{GSS}$	±20	V
Continuous Drain Current, VGS = 10V (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	lo	9.3 6.6	Α
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	lo	45 32	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	90	Α	
Maximum Continuous Body Diode Forward Current (Note 6)		ls	45	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		Ism	90	Α
Avalanche Current (Note 7), L=0.1mH		las	15.8	Α
Avalanche Energy (Note 7), L=0.1mH		Eas	12.5	mJ
Avalanche Current (Note 7), L=3mH		las	8	Α
Avalanche Energy (Note 7), L=3mH		Eas	96	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	$P_{D}$	3.2	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	46	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	79	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.



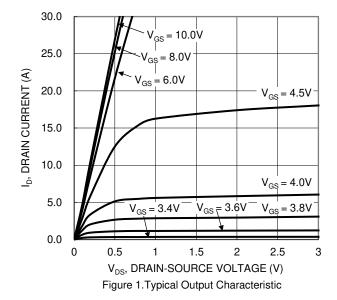
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 80V$ , $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Daggan	_	18	23	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Nesistance	RDS(ON)	_	21	30	11177	$V_{GS} = 6V, I_{D} = 12.5A$	
Diode Forward Voltage	$V_{SD}$	_	0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		1477		pF	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V f = 1MHz	
Output Capacitance	Coss	_	263	_			
Reverse Transfer Capacitance	Crss	_	20	_			
Gate Resistance	Rg	_	1.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	21	_		V 50V L 00A	
Gate-Source Charge	Qgs	_	5.7	_	nC	$V_{DD} = 50V, I_D = 20A, V_{GS} = 10V$	
Gate-Drain Charge	Qgd	_	3.8	_			
Turn-On Delay Time	td(on)	_	6.3	_		$\begin{split} V_{DD} &= 50 V,  V_{GS} = 10 V, \\ I_{D} &= 20 A,  R_{g} = 6 \Omega \end{split}$	
Turn-On Rise Time	t <sub>R</sub>	_	9.4	_			
Turn-Off Delay Time	tD(OFF)	_	16.7	_	ns		
Turn-Off Fall Time	tr	_	8.2	_			
Reverse Recovery Time	trr	_	38.7	_	ns	I- 00 A di/dk 100 A /	
Reverse Recovery Charge	Qrr	_	53.7		nC	IF = 20A, di/dt = 100A/μs	

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:







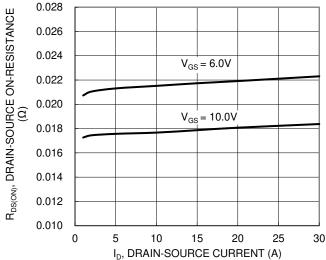


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

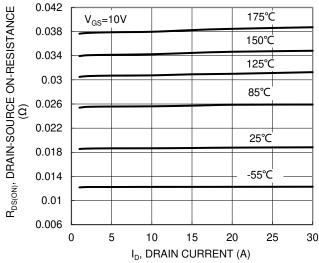


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

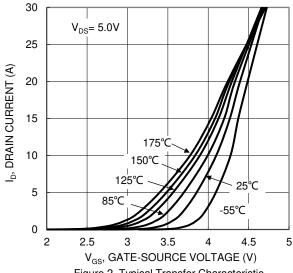
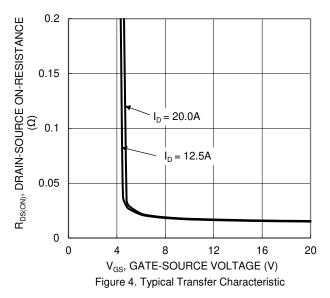


Figure 2. Typical Transfer Characteristic



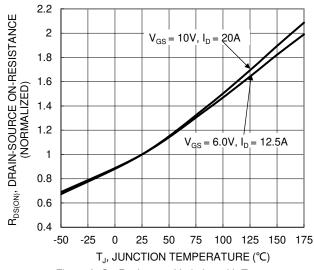


Figure 6. On-Resistance Variation with Temperature



## DMTH10H025LPSQ

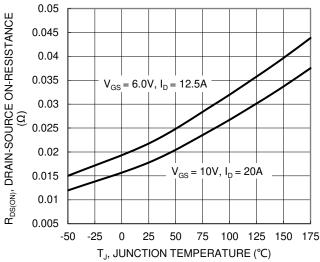


Figure 7. On-Resistance Variation with Temperature

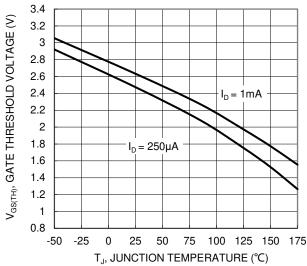


Figure 8. Gate Threshold Variation vs. Junction Temperature

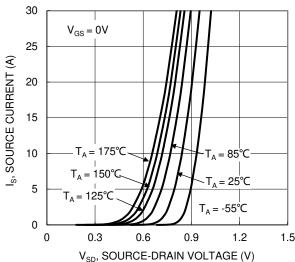
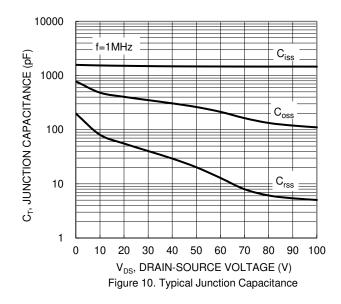
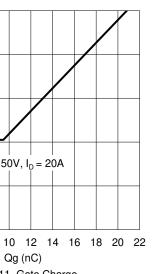


Figure 9. Diode Forward Voltage vs. Current







1000 R<sub>DS(ON)</sub> LIMITED 100 ID, DRAIN CURRENT (A) 10 -P<sub>w</sub>=100µs  $T_{J(MAX)}=175$ °C P<sub>,Wi</sub>=,1ms T<sub>C</sub>=25°C Single Pulse DUT on infinite heatsink V<sub>GS</sub>=10V 0.01 1 0.1 10 100 1000 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

Qg (nC) Figure 11. Gate Charge

6 8

4

 $V_{DS} = 50V, I_{D} = 20A$ 

10

8

6

4

2

0

0 2



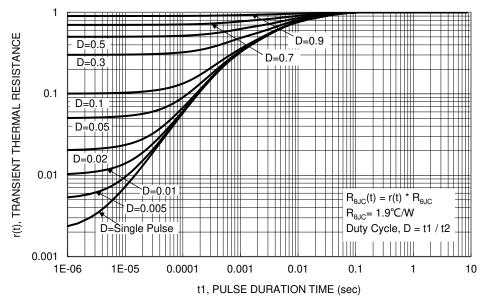


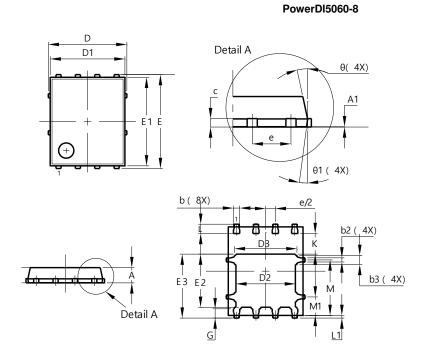
Figure 13. Transient Thermal Resistance



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

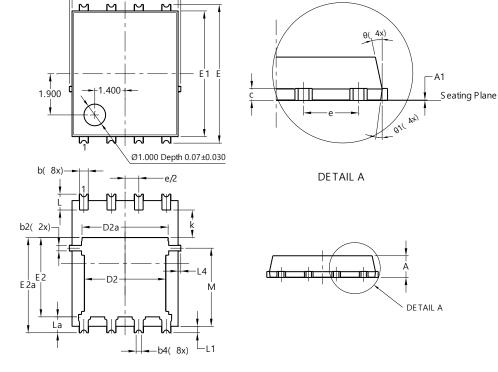
#### Site 1:



Dama * DIFOCO O					
PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
<b>A</b> 1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(	6.15 BSC	,		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

### PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	(	).25REF		
С	0.230	0.330	0.277	
D	5	.15 BS0	$\sim$	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	)	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

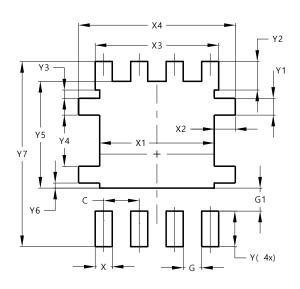


### **Suggested Pad Layout**

 $Please \ see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

#### Site 1:

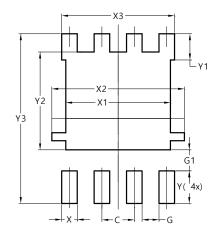
#### PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
<b>Y</b> 7	6.610

Site 2:

### PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
Dillielisions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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